

# 10 DESIGN MISTAKES THAT DRIVE UP PRODUCT COST



# MISTAKE #1

#### Over-Engineering the Design

- Does the design include only essential features?
- Have you avoided high-cost features (e.g. wireless charging) unless truly necessary?
- Is the microcontroller right-sized for the application?

# **MISTAKE #2**

## Overly Expensive PCB Design

- ∃ Is the PCB size optimized (not too large or too small)?
- Are you avoiding extra layers, blind/buried vias, or flex PCBs unless required?
- Are all components SMT where possible for simplified assembly?

# **MISTAKE #3**

# Over-Specified Components

- Are all components matched to actual performance requirements?
- Have you avoided 10x safety margins unless critical?
- Have you reviewed cheaper alternatives for common parts?

# **MISTAKE #4**

#### **Custom Parts Too Early**

- Are you using off-the-shelf components wherever possible?
- Have you delayed custom designs (batteries, chips, etc.) until volumes justify?
- Have you considered certification and lead time implications of custom parts?

#### **MISTAKE #5**

#### Overly Complex or Unnecessary Display

- ☑ Is a display truly necessary, or can a smartphone app handle UI?
- ∃ Is the display size, type, and resolution justified by the use case?
- ∃ Have you considered the downstream cost (power, processor, GUI) of using a display?

# **MISTAKE #6**

#### Using Brand-Name Parts Without Need

- Are you reserving premium brands for critical parts only?
- Have you evaluated reputable low-cost or generic alternatives?
- → Have alternatives been tested or second-sourced?

# **MISTAKE #7**

## Not Designing for Manufacturability (DFM)

- ∃ Is the design optimized for efficient production and assembly?
- Are there any features that could cause slowdowns or defects on the line?
- Have you reviewed DFM guidelines before finalizing the design?

# **MISTAKE #8**

#### **Unnecessary Mechanical Complexity**

- ∃ Is the enclosure as simple as possible (e.g., 2-piece design)?
- Have you avoided advanced mold features (side actions, sliders) where not needed?
- Are fasteners minimized and chosen for ease of assembly?

# **MISTAKE #9**

# Skipping Manufacturing Cost Estimates Early

- Have you obtained early cost estimates (PCBs, components, tooling)?
- → Are BOM, assembly, and packaging costs tracked from the start?
- → Are you validating assumptions about retail price vs. build cost?

# MISTAKE #10

# Skipping Manufacturing Cost Estimates Early

- Is the design power-optimized at both hardware and firmware levels?
- Are you using low-power components and efficient sleep modes?
- Can smaller batteries or regulators be used due to better power management?

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# Meet your guide: John Teel



Hey there, I'm a former microchip design engineer at Texas Instruments and founder of a hardware startup that sold products in hundreds of retail stores. My chip designs are in devices from Apple, Intel, and more.

Now, my full-time focus is helping people like you bring new electronic products to life, without wasting time, money, or risking everything.

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